9. Major Subsequent Events

After the completion of the first half of FY2012, Fujitsu issued the following straight bonds.

30th Series Unsecured Straight Bonds

- 1. Total amount of issue 40 billion yen
- 2. Interest rate 0.331% per annum
- 3. Issue price 100% of the denomination of each bond
- 4. Term and redemption methodOctober 16, 2015 (3 years), Bullet repayment
- 5. Payment date October 16, 2012
- 6. Collateral The bonds are not secured by any pledge, mortgage or other charge on any assets or revenues of the Company or of others, nor are they guaranteed. There are no assets reserved as security for the bonds.
- 7. Application of funds The amount is scheduled to be allocated for redemption and repayment of the bonds and loans that will reach maturity by the end of March, 2013.

31st Series Unsecured Straight Bonds

- 1. Total amount of issue 20 billion yen
- 2. Interest rate 0.476% per annum
- 3. Issue price 100% of the denomination of each bond
- 4. Term and redemption method October 16, 2017 (5 years), Bullet repayment
- 5. Payment date October 16, 2012
- 6. Collateral The bonds are not secured by any pledge, mortgage or other charge on any assets or revenues of the Company or of others, nor are they guaranteed. There are no assets reserved as security for the bonds.
- 7. Application of funds The amount is scheduled to be allocated for redemption and repayment of the bonds and loans that will reach maturity by the end of March, 2013.